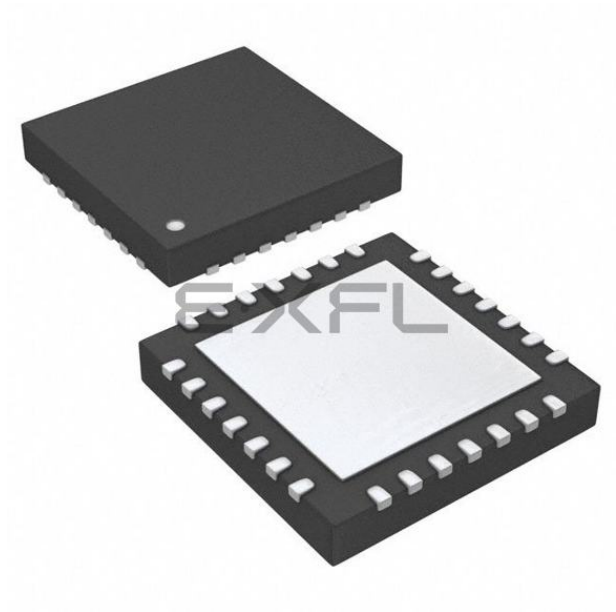

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
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TABLE 3-13: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	PIC16(L)F18856	PIC16(L)F18876	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 30 (Continued)													
F31h	RE1PPS	—	X	—	—	RE1PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F32h	RE2PPS	—	X	—	—	RE2PPS<5:0>						--00 0000	--uu uuuu
		X	—	Unimplemented								---- ----	---- ----
F33h — F37h	—	—		Unimplemented								—	—
F38h	ANSELA			ANSA7	ANSA6	ANSA5	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	1111 1111	1111 1111
F39h	WPUA			WPUA7	WPUA6	WPUA5	WPUA4	WPUA3	WPUA2	WPUA1	WPUA0	0000 0000	0000 0000
F3Ah	ODCONA			ODCA7	ODCA6	ODCA5	ODCA4	ODCA3	ODCA2	ODCA1	ODCA0	0000 0000	0000 0000
F3Bh	SLRCONA			SLRA7	SLRA6	SLRA5	SLRA4	SLRA3	SLRA2	SLRA1	SLRA0	1111 1111	1111 1111
F3Ch	INLVLA			INLVLA7	INLVLA6	INLVLA5	INLVLA4	INLVLA3	INLVLA2	INLVLA1	INLVLA0	1111 1111	1111 1111
F3Dh	IOCAP			IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0	0000 0000	0000 0000
F3Eh	IOCAN			IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0	0000 0000	0000 0000
F3Fh	IOCAF			IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0	0000 0000	0000 0000
F40h	CCDNA			CCDNA7	CCDNA6	CCDNA5	CCDNA4	CCDNA3	CCDNA2	CCDNA1	CCDNA0	0000 0000	0000 0000
F41h	CCDPA			CCDPA7	CCDPA6	CCDPA5	CCDPA4	CCDPA3	CCDPA2	CCDPA1	CCDPA0	0000 0000	0000 0000
F42h	—	—		Unimplemented								—	—
F43h	ANSELB			ANSB7	ANSB6	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	1111 1111	1111 1111
F44h	WPUB			WPUB7	WPUB6	WPUB5	WPUB4	WPUB3	WPUB2	WPUB1	WPUB0	0000 0000	0000 0000
F45h	ODCONB			ODCB7	ODCB6	ODCB5	ODCB4	ODCB3	ODCB2	ODCB1	ODCB0	0000 0000	0000 0000
F46h	SLRCONB			SLRB7	SLRB6	SLRB5	SLRB4	SLRB3	SLRB2	SLRB1	SLRB0	1111 1111	1111 1111

Legend: x = unknown, u = unchanged, q =depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

Note 1: Register present on PIC16F18855/75 devices only.

2: Unimplemented, read as '1'.

TABLE 6-1: NOSC/COSC BIT SETTINGS

NOSC<2:0>/ COSC<2:0>	Clock Source
111	EXTOSC(1)
110	HFINTOSC(2)
101	LFINTOSC
100	SOSC
011	Reserved (it operates like NOSC = 110)
010	EXTOSC with 4x PLL(1)
001	HFINTOSC with 2x PLL(1)
000	Reserved (it operates like NOSC = 110)

Note 1: EXTOSC configured by the FEXTOSC bits of Configuration Word 1 (Register 4-1).

2: HFINTOSC settings are configured with the HFFRQ bits of the OSCFRQ register (Register 6-6).

TABLE 6-2: NDIV/CDIV BIT SETTINGS

NDIV<3:0>/ CDIV<3:0>	Clock divider
1111-1010	Reserved
1001	512
1000	256
0111	128
0110	64
0101	32
0100	16
0011	8
0010	4
0001	2
0000	1

REGISTER 6-3: OSCCON3: OSCILLATOR CONTROL REGISTER 3

R/W/HC-0/0	R/W-0/0	U-0	R-0/0	R-0/0	U-0	U-0	U-0
CSWHOLD	SOSCPWR	—	ORDY	NOSCR	—	—	—
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **CSWHOLD:** Clock Switch Hold bit
- 1 = Clock switch will hold (with interrupt) when the oscillator selected by NOSC is ready
- 0 = Clock switch may proceed when the oscillator selected by NOSC is ready; if this bit is clear at the time that NOSCR becomes ‘1’, the switch will occur

bit 6 **SOSCPWR:** Secondary Oscillator Power Mode Select bit
- 1 = Secondary oscillator operating in High-power mode
- 0 = Secondary oscillator operating in Low-power mode

bit 5 **Unimplemented:** Read as ‘0’.

bit 4 **ORDY:** Oscillator Ready bit (read-only)
- 1 = OSCCON1 = OSCCON2; the current system clock is the clock specified by NOSC
- 0 = A clock switch is in progress

bit 3 **NOSCR:** New Oscillator is Ready bit (read-only)
- 1 = A clock switch is in progress and the oscillator selected by NOSC indicates a “ready” condition
- 0 = A clock switch is not in progress, or the NOSC-selected oscillator is not yet ready

bit 2-0 **Unimplemented:** Read as ‘0’

TABLE 7-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIE0	—	—	TMR0IE	IOCIE	—	—	—	INTE	135
PIE1	OSFIE	CSWIE	—	—	—	—	ADTIE	ADIE	136
PIE2	—	ZCDIE	—	—	—	—	C2IE	C1IE	137
PIE3	—	—	RCIE	TXIE	BCL2IE	SSP2IE	BCL1IE	SSP1IE	138
PIE4	—	—	TMR6IE	TMR5IE	TMR4IE	TMR3IE	TMR2IE	TMR1IE	139
PIE5	CLC4IE	CLC3IE	CLC2IE	CLC1IE	—	TMR5GIE	TMR3GIE	TMR1GIE	140
PIE6	—	—	—	CCP5IE	CCP4IE	CCP3IE	CCP2IE	CCP1IE	141
PIE7	SCANIE	CRCIE	NVMIE	NCO1IE	—	CWG3IE	CWG2IE	CWG1IE	142
PIE8	—	—	SMT2PWAIE	SMT2PRAIE	SMT2IE	SMT1PWAIE	SMT1PRAIE	SMT1IE	143
PIR0	—	—	TMR0IF	IOCIF	—	—	—	INTF	144
PIR1	OSFIF	CSWIF	—	—	—	—	ADTIF	ADIF	145
PIR2	—	ZCDIF	—	—	—	—	C2IF	C1IF	146
PIR3	—	—	RCIF	TXIF	BCL2IF	SSP2IF	BCL1IF	SSP1IF	147
PIR4	—	—	TMR6IF	TMR5IF	TMR4IF	TMR3IF	TMR2IF	TMR1IF	148
PIR5	CLC4IF	CLC3IF	CLC2IF	CLC1IF	—	TMR5GIF	TMR3GIF	TMR1GIF	149
PIR6	—	—	—	CCP5IF	CCP4IF	CCP3IF	CCP2IF	CCP1IF	150
PIR7	SCANIF	CRCIF	NVMIF	NCO1IF	—	CWG3IF	CWG2IF	CWG1IF	152
PIR8	—	—	SMT2PWAIF	SMT2PRAIF	SMT2IF	SMT1PWAIF	SMT1PRAIF	SMT1IF	153

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by interrupts.

REGISTER 10-5: NVMCON1: NONVOLATILE MEMORY CONTROL 1 REGISTER

U-0	R/W-0/0	R/W-0/0	R/W/HC-0/0	R/W/HC-x/q	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
—	NVMREGS	LWLO	FREE	WRERR(1,2,3)	WREN	WR(4,5,6)	RD(7)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
S = Bit can only be set	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **Unimplemented:** Read as '0'

bit 6 **NVMREGS:** Configuration Select bit
1 = Access EEPROM, Configuration, User ID and Device ID Registers
0 = Access PFM

bit 5 **LWLO:** Load Write Latches Only bit
When FREE = 0:
1 = The next WR command updates the write latch for this word within the row; no memory operation is initiated.
0 = The next WR command writes data or erases
Otherwise: The bit is ignored

bit 4 **FREE:** PFM Erase Enable bit
When NVMREGS:NVMADR points to a PFM location:
1 = Performs an erase operation with the next WR command; the 32-word pseudo-row containing the indicated address is erased (to all 1s) to prepare for writing.
0 = All write operations have completed normally

bit 3 **WRERR:** Program/Erase Error Flag bit(1,2,3)
This bit is normally set by hardware.
1 = A write operation was interrupted by a Reset, interrupted unlock sequence, or WR was written to one while NVMADR points to a write-protected address.
0 = The program or erase operation completed normally

bit 2 **WREN:** Program/Erase Enable bit
1 = Allows program/erase cycles
0 = Inhibits programming/erasing of program Flash

bit 1 **WR:** Write Control bit(4,5,6)
When NVMREG:NVMADR points to a EEPROM location:
1 = Initiates an erase/program cycle at the corresponding EEPROM location
0 = NVM program/erase operation is complete and inactive
When NVMREG:NVMADR points to a PFM location:
1 = Initiates the operation indicated by Table 10-4
0 = NVM program/erase operation is complete and inactive
Otherwise: This bit is ignored

bit 0 **RD:** Read Control bit(7)
1 = Initiates a read at address = NVMADR1, and loads data to NVMDAT Read takes one instruction cycle and the bit is cleared when the operation is complete. The bit can only be set (not cleared) in software.
0 = NVM read operation is complete and inactive

Note 1: Bit is undefined while WR = 1 (during the EEPROM write operation it may be '0' or '1').
2: Bit must be cleared by software; hardware will not clear this bit.
3: Bit may be written to '1' by software in order to implement test sequences.
4: This bit can only be set by following the unlock sequence of **Section 10.4.2 "NVM Unlock Sequence"**.
5: Operations are self-timed, and the WR bit is cleared by hardware when complete.
6: Once a write operation is initiated, setting this bit to zero will have no effect.
7: Reading from EEPROM loads only NVMDATL<7:0> (Register 10-1).

12.14.8 CURRENT-CONTROLLED DRIVE MODE CONTROL

The CCDPE and CCDNE registers (Register 12-53 and Register 12-54) control the Current-Controlled Drive mode for both the positive-going and negative-going drivers. When a CCDPE[y] or CCDNE[y] bit is set and the CCDEN bit of the CCDCON register is set, the Current-Controlled mode is enabled for the corresponding port pin. When the CCDPE[y] or CCDNE[y] bit is clear, the Current-Controlled mode for the corresponding port pin is disabled. If the CCDPE[y] or CCDNE[y] bit is set and the CCDEN bit is clear, operation of the port pin is undefined (see **Section 12.1.1 "Current-Controlled Drive"** for current-controlled use precautions).

12.14.9 PORTE FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 13.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

12.14.10 PORTE FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 13.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

REGISTER 15-4: IOCBP: INTERRUPT-ON-CHANGE PORTB POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCBP7	IOCBP6	IOCBP5	IOCBP4	IOCBP3	IOCBP2	IOCBP1	IOCBP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCBP<7:0>:** Interrupt-on-Change PORTB Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCBFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin.

REGISTER 15-5: IOCBN: INTERRUPT-ON-CHANGE PORTB NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCBN7	IOCBN6	IOCBN5	IOCBN4	IOCBN3	IOCBN2	IOCBN1	IOCBN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCBN<7:0>:** Interrupt-on-Change PORTB Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCBFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin.

REGISTER 15-6: IOCBF: INTERRUPT-ON-CHANGE PORTB FLAG REGISTER

R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
IOCBF7	IOCBF6	IOCBF5	IOCBF4	IOCBF3	IOCBF2	IOCBF1	IOCBF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS - Bit is set in hardware

bit 7-0 **IOCBF<7:0>:** Interrupt-on-Change PORTB Flag bits
1 = An enabled change was detected on the associated pin.
Set when IOCBPx = 1 and a rising edge was detected on RBx, or when IOCBNx = 1 and a falling edge was detected on RBx.
0 = No change was detected, or the user cleared the detected change.

20.12 Configuring the CWG

The following steps illustrate how to properly configure the CWG.

1. Ensure that the TRIS control bits corresponding to the desired CWG pins for your application are set so that the pins are configured as inputs.
2. Clear the EN bit, if not already cleared.
3. Set desired mode of operation with the MODE bits.
4. Set desired dead-band times, if applicable to mode, with the CWGxDBR and CWGxDBF registers.
5. Setup the following controls in the CWGxAS0 and CWGxAS1 registers.
   a. Select the desired shutdown source.
   b. Select both output overrides to the desired levels (this is necessary even if not using auto-shutdown because start-up will be from a shutdown state).
   c. Set which pins will be affected by auto-shutdown with the CWGxAS1 register.
   d. Set the SHUTDOWN bit and clear the REN bit.
6. Select the desired input source using the CWGxISM register.
7. Configure the following controls.
   a. Select desired clock source using the CWGxCLKCON register.
   b. Select the desired output polarities using the CWGxCON1 register.
   c. Set the output enables for the desired outputs.
8. Set the EN bit.
9. Clear TRIS control bits corresponding to the desired output pins to configure these pins as outputs.
10. If auto-restart is to be used, set the REN bit and the SHUTDOWN bit will be cleared automatically. Otherwise, clear the SHUTDOWN bit to start the CWG.

20.12.1 PIN OVERRIDE LEVELS

The levels driven to the output pins, while the shutdown input is true, are controlled by the LSBD and LSAC bits of the CWGxAS0 register. LSBD<1:0> controls the CWGxB and D override levels and LSAC<1:0> controls the CWGxA and C override levels. The control bit logic level corresponds to the output logic drive level while in the shutdown state. The polarity control does not affect the override level.

20.12.2 AUTO-SHUTDOWN RESTART

After an auto-shutdown event has occurred, there are two ways to resume operation:

- Software controlled
- Auto-restart

The restart method is selected with the REN bit of the CWGxCON2 register. Waveforms of software controlled and automatic restarts are shown in Figure 20-13 and Figure 20-14.

20.12.2.1 Software Controlled Restart

When the REN bit of the CWGxAS0 register is cleared, the CWG must be restarted after an auto-shutdown event by software. Clearing the shutdown state requires all selected shutdown inputs to be low, otherwise the SHUTDOWN bit will remain set. The overrides will remain in effect until the first rising edge event after the SHUTDOWN bit is cleared. The CWG will then resume operation.

20.12.2.2 Auto-Restart

When the REN bit of the CWGxCON2 register is set, the CWG will restart from the auto-shutdown state automatically. The SHUTDOWN bit will clear automatically when all shutdown sources go low. The overrides will remain in effect until the first rising edge event after the SHUTDOWN bit is cleared. The CWG will then resume operation.

22.7 Register Definitions: CLC Control

REGISTER 22-1: CLCxCON: CONFIGURABLE LOGIC CELL CONTROL REGISTER

R/W-0/0	U-0	R-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
LCxEN	—	LCxOUT	LCxINTP	LCxINTN	LCxMODE<2:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **LCxEN:** Configurable Logic Cell Enable bit
1 = Configurable logic cell is enabled and mixing input signals
0 = Configurable logic cell is disabled and has logic zero output

bit 6 **Unimplemented:** Read as ‘0’

bit 5 **LCxOUT:** Configurable Logic Cell Data Output bit
Read-only: logic cell output data, after LCPOL; sampled from CLCxOUT

bit 4 **LCxINTP:** Configurable Logic Cell Positive Edge Going Interrupt Enable bit
1 = CLCxIF will be set when a rising edge occurs on CLCxOUT
0 = CLCxIF will not be set

bit 3 **LCxINTN:** Configurable Logic Cell Negative Edge Going Interrupt Enable bit
1 = CLCxIF will be set when a falling edge occurs on CLCxOUT
0 = CLCxIF will not be set

bit 2-0 **LCxMODE<2:0>:** Configurable Logic Cell Functional Mode bits
111 = Cell is 1-input transparent latch with S and R
110 = Cell is J-K flip-flop with R
101 = Cell is 2-input D flip-flop with R
100 = Cell is 1-input D flip-flop with S and R
011 = Cell is S-R latch
010 = Cell is 4-input AND
001 = Cell is OR-XOR
000 = Cell is AND-OR

REGISTER 23-2: ADCON1: ADC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	U-0	R/W-0/0
ADPPOL	ADIPEN	ADGPOL	—	—	—	—	ADDSEN
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **ADDPOL:** Precharge Polarity bit
If ADPRE>0x00:

ADPPOL	Action During 1st Precharge Stage	
	External (selected analog I/O pin)	Internal (AD sampling capacitor)
1	Shorted to AV_{DD}	C_{HOLD} shorted to V_{SS}
0	Shorted to V_{SS}	C_{HOLD} shorted to AV_{DD}

Otherwise
The bit is ignored

bit 6 **ADIPEN:** A/D Inverted Precharge Enable bit
If ADDSEN = 1:
1 = The precharge and guard signals in the second conversion cycle are the opposite polarity of the first cycle
0 = Both Conversion cycles use the precharge and guards specified by ADPPOL and ADGPOL
Otherwise:
The bit is ignored

bit 5 **ADGPOL:** Guard Ring Polarity Selection bit
1 = ADC guard ring outputs start as digital high during precharge stage
0 = ADC guard ring outputs start as digital low during precharge stage

bit 4-1 **Unimplemented:** Read as '0'

bit 0 **ADDSEN:** Double-Sample Enable bit
1 = See Table 23-5.
0 = One conversion is performed for each trigger

TABLE 23-5: EXAMPLE OF REGISTER VALUES FOR ACCUMULATE AND AVERAGE MODES

Trigger ADCONT		Sample n	ADRES	ADPREV ADPSIS		ADACC
0	1			0	1	
T1	T1	1	S(n)	S(n-1)	ADFLTR(n-1)	ADACC(n-1)-S(n-1)
T2	—	2	S(n)	S(n-1)	ADFLTR(n-2)	ADACC(n-1)+S(n-1)
T3	T2	3	S(n)	S(n-1)	ADFLTR(n-1)	ADACC(n-1)-S(n-1)
T4	—	4	S(n)	S(n-1)	ADFLTR(n-2)	ADACC(n-1)+S(n-1)
T5	T3	5	S(n)	S(n-1)	ADFLTR(n-1)	ADACC(n-1)-S(n-1)
T6	—	6	S(n)	S(n-1)	ADFLTR(n-2)	ADACC(n-1)+S(n-1)

REGISTER 23-8: ADPCH: ADC POSITIVE CHANNEL SELECTION REGISTER

U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	ADPCH<5:0>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **Unimplemented**: Read as '0'

bit 5-0 **ADPCH<5:0>**: ADC Positive Input Channel Selection bits

111111 = Fixed Voltage Reference (FVR)(2)
111110 = DAC1 output(1)
111101 = Temperature Indicator(3)
111100 = AVSS (Analog Ground)
111011 = Reserved. No channel connected.
•
•
•
100010 = ANE2(4)
100001 = ANE1(4)
100000 = ANE0(4)
011111 = AND7(4)
011110 = AND6(4)
011101 = AND5(4)
011100 = AND4(4)
011011 = AND3(4)
011010 = AND2(4)
011001 = AND1(4)
011000 = AND0(4)
010111 = ANC7
010110 = ANC6
010101 = ANC5
010100 = ANC4
010011 = ANC3
010010 = ANC2
010001 = ANC1
010000 = ANC0
001111 = ANB7
001110 = ANB6
001101 = ANB5
001100 = ANB4
001011 = ANB3
001010 = ANB2
001001 = ANB1
001000 = ANB0
000111 = ANA7
000110 = ANA6
000101 = ANA5
000100 = ANA4
000011 = ANA3
000010 = ANA2
000001 = ANA1
000000 = ANA0

Note 1: See **Section 25.0 "5-Bit Digital-to-Analog Converter (DAC1) Module"** for more information.
2: See **Section 16.0 "Fixed Voltage Reference (FVR)"** for more information.
3: See **Section 17.0 "Temperature Indicator Module"** for more information.
4: PIC16(L)F18875 only.

REGISTER 23-21: ADPREVL: ADC PREVIOUS RESULT REGISTER

R-x	R-x	R-x	R-x	R-x	R-x	R-x	R-x
ADPREV<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ADPREV<7:0>**: Previous ADC Results Least Significant Byte
If ADPSIS = 1:
Least Significant Byte of ADFLTR at the start of current ADC conversion
If ADPSIS = 0:
Least Significant bits of ADRES at the start of current ADC conversion(1)

Note 1: If ADPSIS = 0, ADPREVH and ADPREVL are formatted the same way as ADRES is, depending on the ADFRM bit.

REGISTER 23-22: ADACCH: ADC ACCUMULATOR REGISTER HIGH

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADACC<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ADACC<15:8>**: ADC Accumulator MSB. Most Significant seven bits of accumulator value and sign bit.

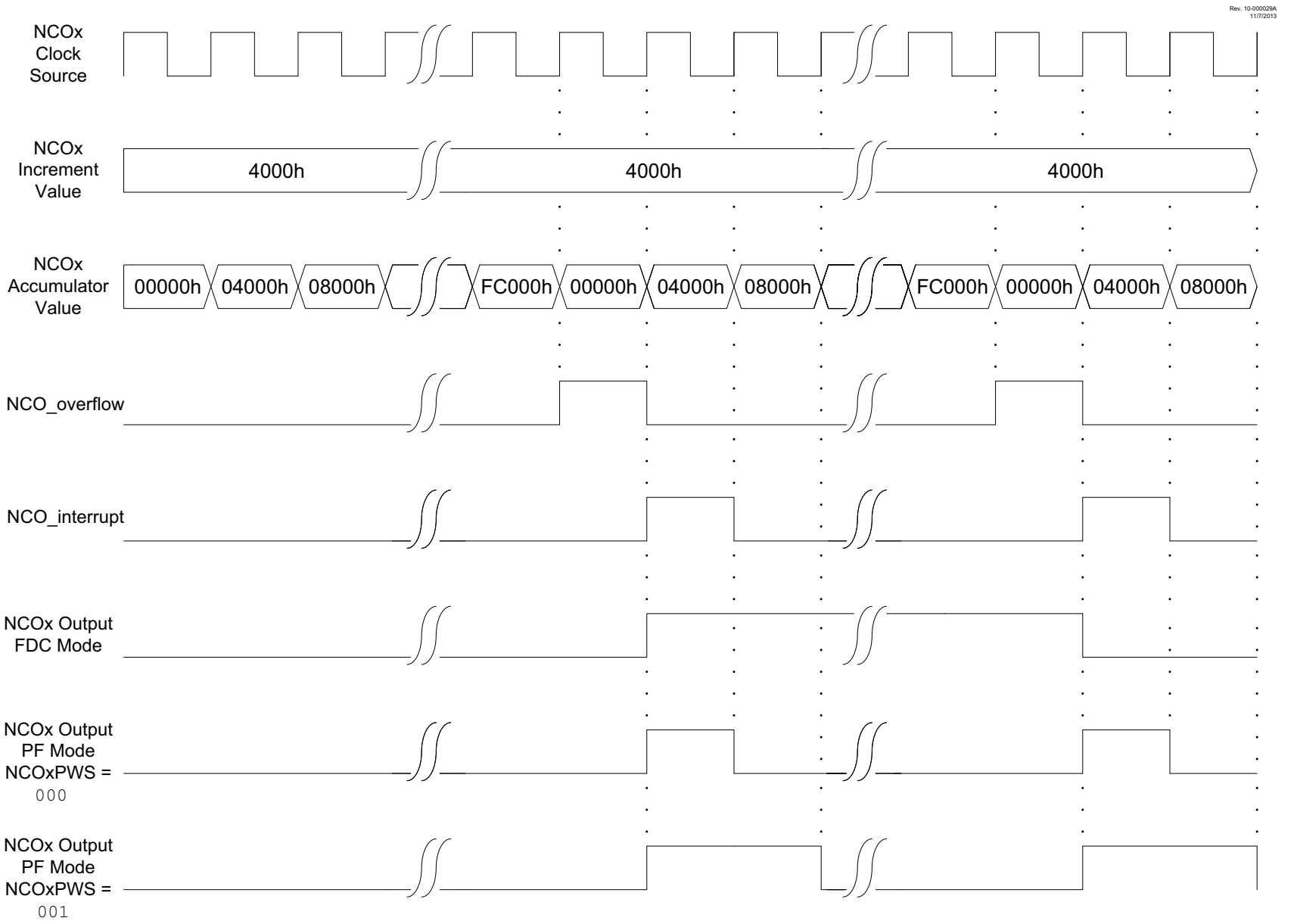
REGISTER 23-23: ADACCL: ADC ACCUMULATOR REGISTER LOW

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
ADACC<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **ADACC<7:0>**: ADC Accumulator LSB. Least Significant eight bits of accumulator value.

FIGURE 24-2: FDC OUTPUT MODE OPERATION DIAGRAM



29.5 Operation Examples

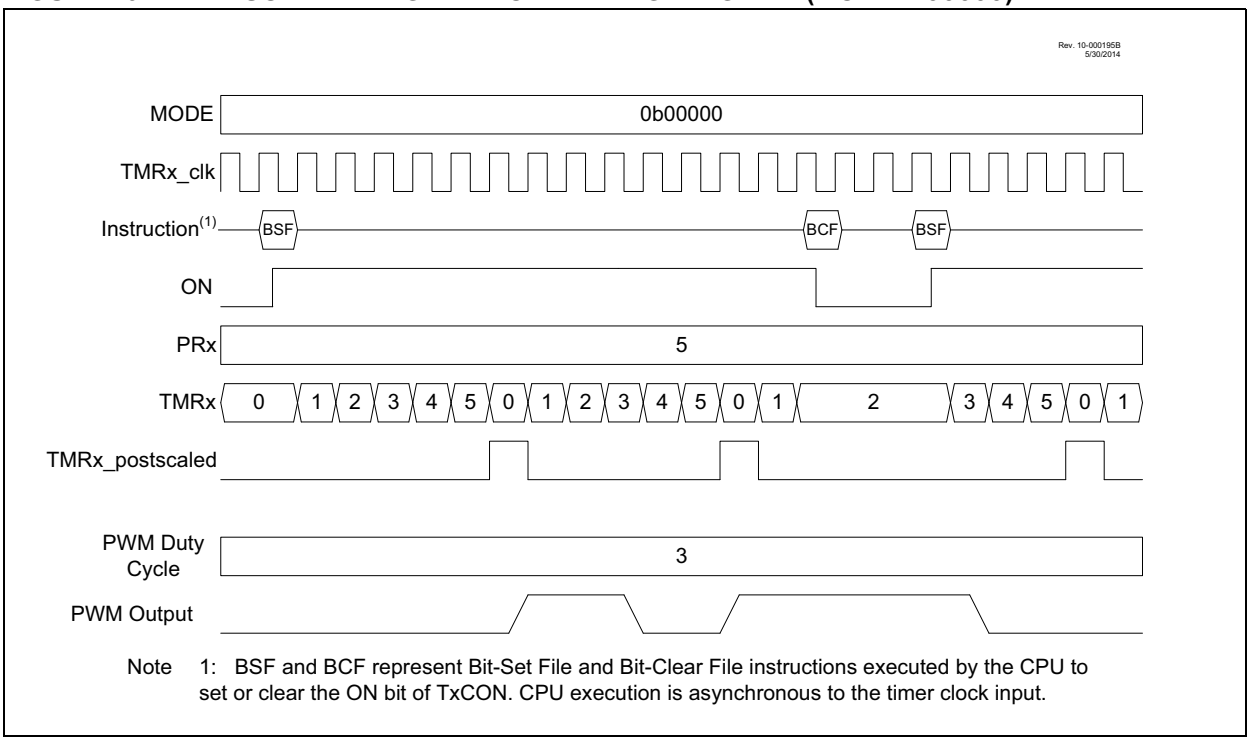
Unless otherwise specified, the following notes apply to the following timing diagrams:

- Both the prescaler and postscaler are set to 1:1 (both the CKPS and OUTPS bits in the TxCON register are cleared).
- The diagrams illustrate any clock except Fosc/4 and show clock-sync delays of at least two full cycles for both ON and Timer2_ers. When using Fosc/4, the clock-sync delay is at least one instruction period for Timer2_ers; ON applies in the next instruction period.
- The PWM Duty Cycle and PWM output are illustrated assuming that the timer is used for the PWM function of the CCP module as described in **Section 30.0 "Capture/Compare/PWM Modules"**. The signals are not a part of the Timer2 module.

29.5.1 SOFTWARE GATE MODE

This mode corresponds to legacy Timer2 operation. The timer increments with each clock input when ON = 1 and does not increment when ON = 0. When the TMRx count equals the PRx period count the timer resets on the next clock and continues counting from 0. Operation with the ON bit software controlled is illustrated in Figure 29-4. With PRx = 5, the counter advances until TMRx = 5, and goes to zero with the next clock.

FIGURE 29-4: SOFTWARE GATE MODE TIMING DIAGRAM (MODE = 00000)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

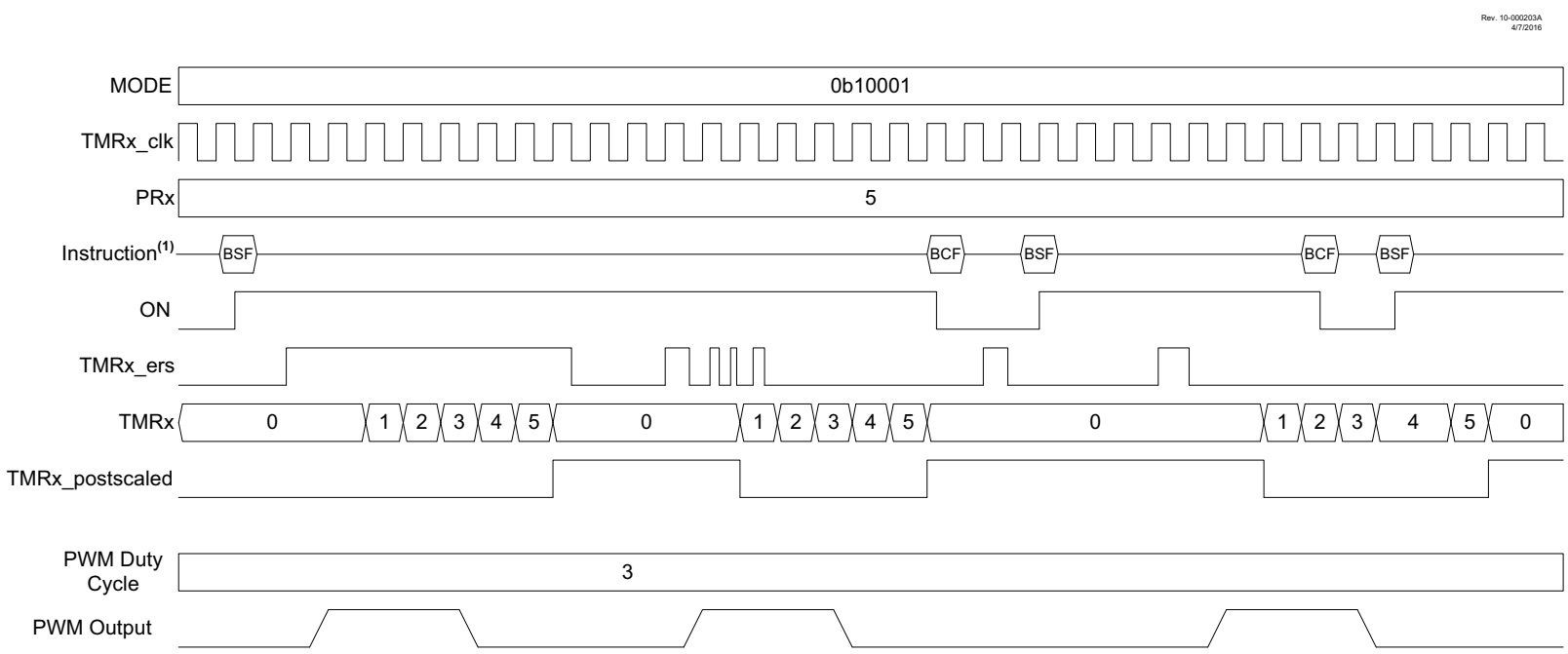
29.5.9 EDGE-TRIGGERED MONOSTABLE MODES

The Edge-Triggered Monostable modes start the timer on an edge from the external Reset signal input, after the ON bit is set, and stop incrementing the timer when the timer matches the PRx period value. The following edges will start the timer:

- Rising edge (MODE<4:0> = 10001)
- Falling edge (MODE<4:0> = 10010)
- Rising or Falling edge (MODE<4:0> = 10011)

When an Edge-Triggered Monostable mode is used in conjunction with the CCP PWM operation the PWM drive goes active with the external Reset signal edge that starts the timer, but will not go active when the timer matches the PRx value. While the timer is incrementing, additional edges on the external Reset signal will not affect the CCP PWM.

FIGURE 29-12: RISING EDGE-TRIGGERED MONOSTABLE MODE TIMING DIAGRAM (MODE = 10001)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

TABLE 29-3: SUMMARY OF REGISTERS ASSOCIATED WITH TIMER2

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CCP1CON	EN	—	OUT	FMT	MODE<3:0>				452
CCP2CON	EN	—	OUT	FMT	MODE<3:0>				452
CCPTMRS0	C4TSEL<1:0>		C3TSEL<1:0>		C2TSEL<1:0>		C1TSEL<1:0>		455
CCPTMRS1	—	—	P7TSEL<1:0>		P6TSEL<1:0>		C5TSEL<1:0>		455
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIE1	OSFIE	CSWIE	—	—	—	—	ADTIE	ADIE	136
PIR1	OSFIF	CSWIF	—	—	—	—	ADTIF	ADIF	145
PR2	Timer2 Module Period Register								425*
TMR2	Holding Register for the 8-bit TMR2 Register								425*
T2CON	ON	CKPS<2:0>			OUTPS<3:0>				441
T2CLKCON	—	—	—	—	CS<3:0>				440
T2RST	—	—	—	RSEL<4:0>					443
T2HLT	PSYNC	CKPOL	CKSYNC	—	MODE<3:0>				442
PR4	Timer4 Module Period Register								425*
TMR4	Holding Register for the 8-bit TMR4 Register								425*
T4CON	ON	CKPS<2:0>			OUTPS<3:0>				441
T4CLKCON	—	—	—	—	—	CS<3:0>			440
T4RST	—	—	—	RSEL<4:0>					443
T4HLT	PSYNC	CKPOL	CKSYNC	—	MODE<3:0>				442
PR6	Timer6 Module Period Register								425*
TMR6	Holding Register for the 8-bit TMR6 Register								425*
T6CON	ON	CKPS<2:0>			OUTPS<3:0>				441
T6CLKCON	—	—	—	—	—	CS<2:0>			440
T6RST	—	—	—	RSEL<4:0>					443
T6HLT	PSYNC	CKPOL	CKSYNC	—	MODE<3:0>				442

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for Timer2 module.

* Page provides register information.

REGISTER 31-7: SSPxBUF: MSSPx BUFFER REGISTER

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
SSPBUF<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **SSPBUF<7:0>:** MSSP Buffer bits

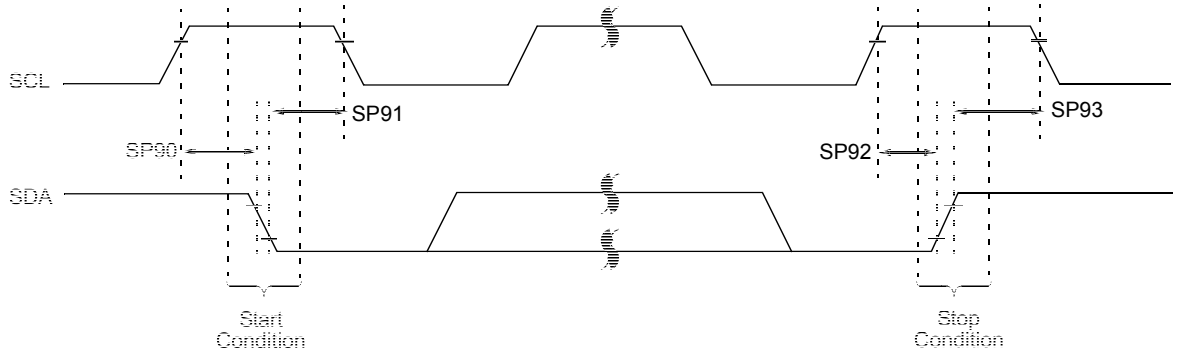
TABLE 31-3: SUMMARY OF REGISTERS ASSOCIATED WITH MSSPx

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	134
PIR3	—	—	RCIF	TXIF	BCL2IF	SSP2IF	BCL1IF	SSP1IF	147
PIE3	—	—	RCIE	TXIE	BCL2IE	SSP2IE	BCL1IE	SSP1IE	138
SSP1STAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	503
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				504
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	505
SSP1CON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	503
SSP1MSK	SSPMSK<7:0>								507
SSP1ADD	SSPADD<7:0>								507
SSP1BUF	SSPBUF<7:0>								508
SSP2STAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	503
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				504
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	505
SSP2CON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	503
SSP2MSK	SSPMSK<7:0>								507
SSP2ADD	SSPADD<7:0>								507
SSP2BUF	SSPBUF<7:0>								508
SSP1CLKPPS	—	—	—	SSP1CLKPPS<4:0>					249
SSP1DATPPS	—	—	—	SSP1DATPPS<4:0>					249
SSP1SSPPS	—	—	—	SSP1SSPPS<4:0>					249
SSP2CLKPPS	—	—	—	SSP2CLKPPS<4:0>					249
SSP2DATPPS	—	—	—	SSP2DATPPS<4:0>					249
SSP2SSPPS	—	—	—	SSP2SSPPS<4:0>					249
RxyPPS	—	—	—	RxyPPS<4:0>					250

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used by the MSSPx module

Note 1: When using designated I^2C pins, the associated pin values in INLVLx will be ignored.

FIGURE 37-21: I²C BUS START/STOP BITS TIMING



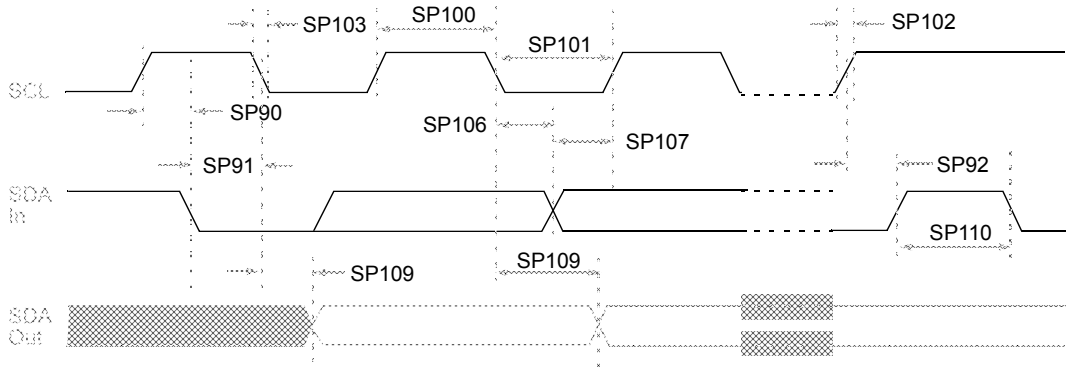
Note: Refer to Figure 37-4 for load conditions.

TABLE 37-24: I²C BUS START/STOP BITS REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)								
Param. No.	**Symbol**	**Characteristic**		**Min.**	**Typ**	**Max.**	**Units**	**Conditions**
SP90*	TSU:STA	Start condition	100 kHz mode	4700	—	—	ns	Only relevant for Repeated Start condition
		Setup time	400 kHz mode	600	—	—		
SP91*	THD:STA	Start condition	100 kHz mode	4000	—	—	ns	After this period, the first clock pulse is generated
		Hold time	400 kHz mode	600	—	—		
SP92*	TSU:STO	Stop condition	100 kHz mode	4700	—	—	ns	
		Setup time	400 kHz mode	600	—	—		
SP93	THD:STO	Stop condition	100 kHz mode	4000	—	—	ns	
		Hold time	400 kHz mode	600	—	—		

* These parameters are characterized but not tested.

FIGURE 37-22: I²C BUS DATA TIMING



Note: Refer to Figure 37-4 for load conditions.

Note: Unless otherwise noted, VIN = 5V, FOSC = 300 kHz, CIN = 0.1 µF, TA = 25°C.

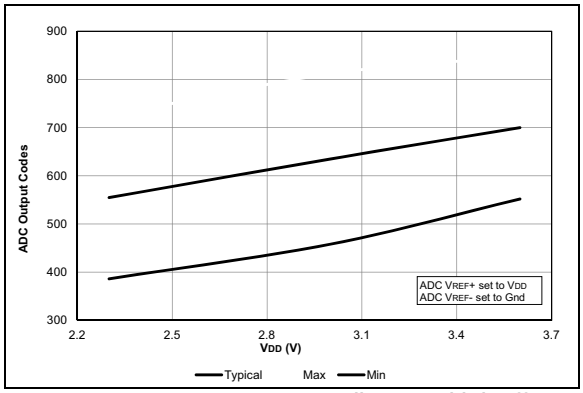


FIGURE 38-43: *Temp. Indicator Initial Offset, Low Range, Temp. = 20°C, PIC16LF18856/76 Only.*

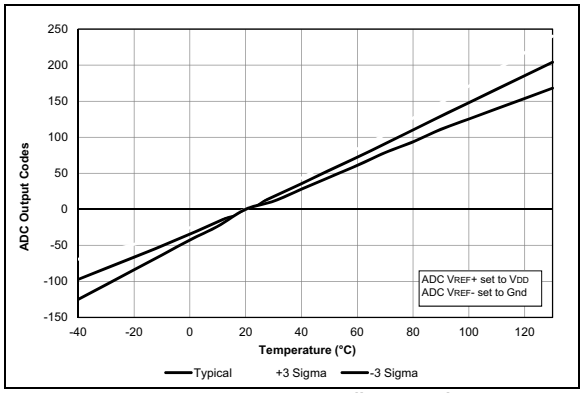


FIGURE 38-46: *Temp. Indicator Slope Normalized to 20°C, High Range, VDD = 3.0V.*

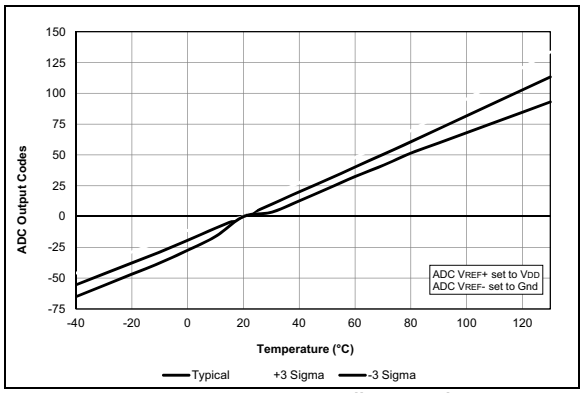


FIGURE 38-44: *Temp. Indicator Slope Normalized to 20°C, High Range, VDD = 5.5V, PIC16F18856/76 Only.*

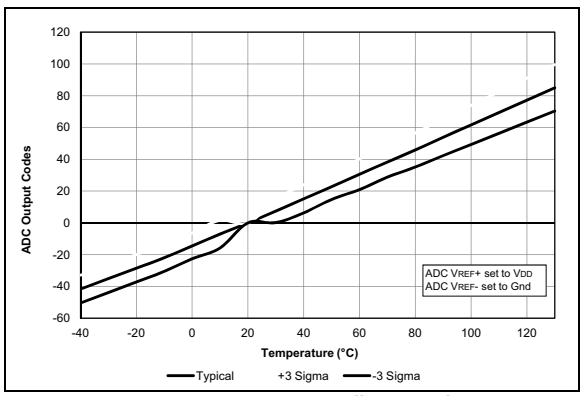


FIGURE 38-47: *Temp. Indicator Slope Normalized to 20°C, Low Range, VDD = 3.6V.*

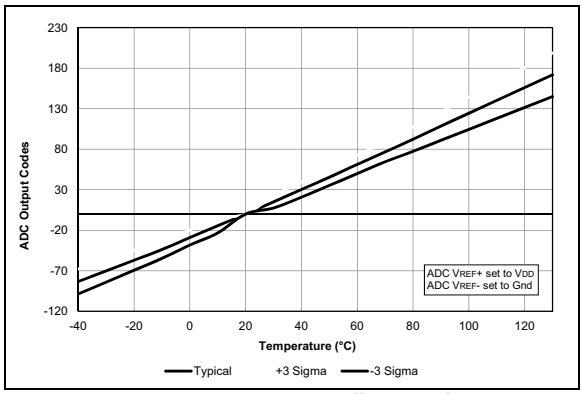


FIGURE 38-45: *Temp. Indicator Slope Normalized to 20°C, High Range, VDD = 3.6V.*

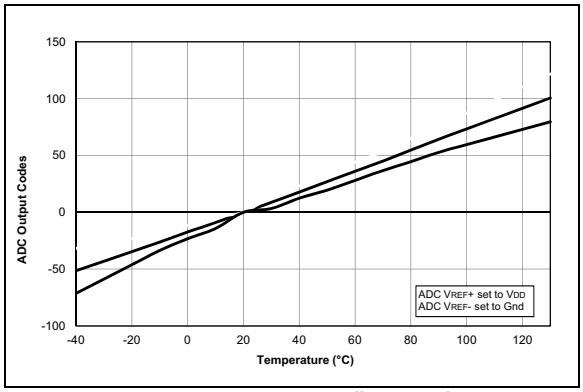


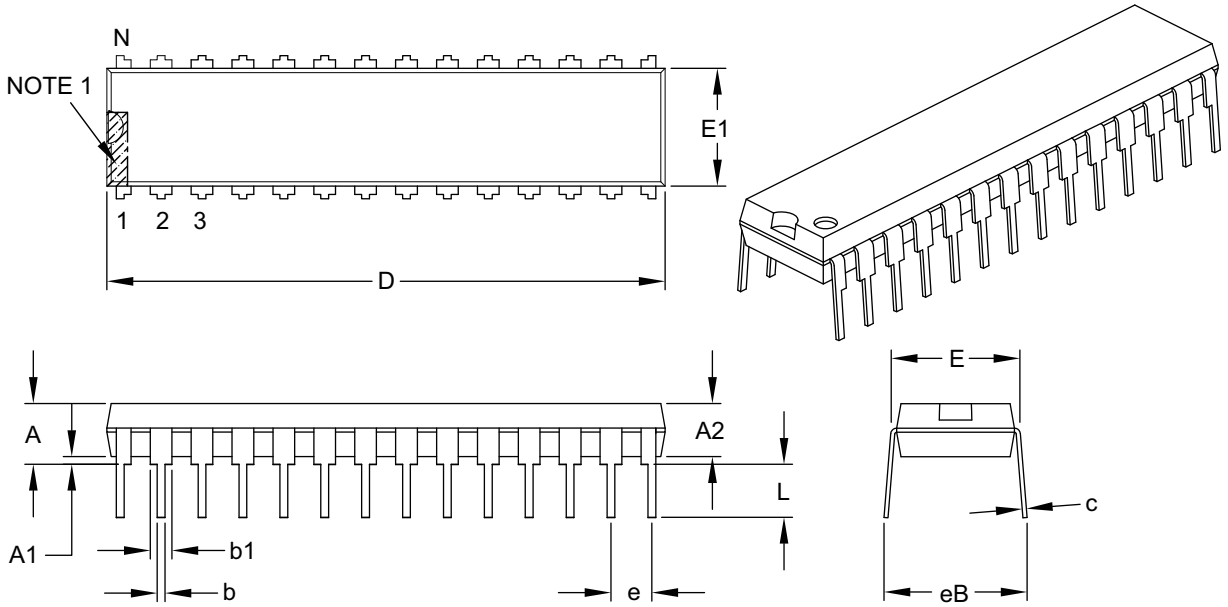
FIGURE 38-48: *Temp. Indicator Slope Normalized to 20°C, Low Range, VDD = 3.0V.*

40.2 Package Details

The following sections give the technical details of the packages.

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B